Wuxi Unigroup Microelectronics Co.,Ltd

800V Super-junction Power MOSFET

Description

800V Super-junction Power MOSFET

Super-junction power MOSFET is a revolutionary technology for high voltage power MOSFETs，designed according to the SJ principle. The deep trench SJ MOSFET provide an extremely low switching, communication and conduction losses device with highest robustness make especially resonant switching applications more reliable, more efficient, lighter and cooler, designed by Wuxi Unigroup Microelectronics Company.

Features

- Very low FOM $R_{DS(on)} \times Q_g$
- 100% avalanche tested
- Easy to use/drive
- RoHS compliant

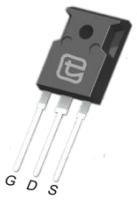
Applications

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)
- Low Power Chargers and Adapters

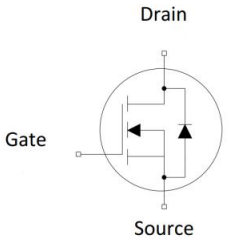
TO-220F

TO-220

TO-247



TO-220FP-NL



RoHS

Device Marking and Package Information

Device	Package	Marking
TPA80R250A	TO-220F	80R250A
TPP80R250A	TO-220	80R250A
TPR80R250A	TO-220F-NL	80R250A
TPW80R250A	TO-247	80R250A

Key Performance Parameters

Parameter	Value	Unit
V_{DS} @ $T_{j,max}$	850	V
$R_{DS(on),max}$	0.28	Ω
$Q_{g,typ}$	62.3	nC
I_D	18	A
$I_{D,pulse}$	54	A
E_{OSS} @ 400V	7.21	μJ

Absolute Maximum Ratings T_C = 25ºC, unless otherwise noted				
Parameter		**Symbol**	**Values**	**Unit**
Continuous Drain Current	T_C = 25ºC	I_D	18	A
	T_C = 100ºC		10.8	
Pulsed Drain Current (note1)		$I_{D,pulse}$	54	A
Gate-Source Voltage		V_{GSS}	±30V	V
Single Pulse Avalanche Energy (note2)		E_{AS}	280	mJ
Repetitive Avalanche Energy (note2)		E_{AR}	0.5	mJ
Avalanche Current		I_{AR}	7.5	A
MOSFET dv/dt Ruggedness, V_{DS} = 0...480V		dv/dt	50	V/ns
Power Dissipation For TO-220F,TO-220F-NL		P_D	34	W
Power Dissipation For TO-220,TO-247			240	
Continuous Diode Forward CurrentF		I_S	18	A
Diode Pulsed Current (note1)		$I_{S,pulse}$	54	
Reverse Diode dv/dt (note3)		dv/dt	15	V/ns
Operating Junction and Storage Temperature Range		T_J, T_{stg}	-55~+150	ºC

Thermal Resistance For TO-220F,TO-220F-NL			
Parameter	**Symbol**	**Value**	**Unit**
Thermal Resistance, Junction-to-Case	R_{thJC}	3.67	ºC/W
Thermal Resistance, Junction-to-Ambient	R_{thJA}	80	

Thermal Resistance For TO-220,TO-247			
Parameter	**Symbol**	**Value**	**Unit**
Thermal Resistance, Junction-to-Case	R_{thJC}	0.52	ºC/W
Thermal Resistance, Junction-to-Ambient	R_{thJA}	62	

Electrical Characteristics T_J = 25ºC, unless otherwise noted

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Static Characteristics						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250μA	800	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 800V, V_{GS} = 0V, T_J = 25ºC	--	--	1	μA
		V_{DS} = 800V, V_{GS} = 0V, T_J = 150ºC	--	--	100	
Gate-Source Leakage Current	I_{GSS}	V_{GS} = ±30V	--	--	±100	nA
Gate-Source Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250μA	2.5	--	4.5	V
Drain-Source On-State-Resistance	$R_{DS(on)}$	V_{GS} = 10V, I_D = 9A	--	0.24	0.28	Ω
Gate Resistance	R_G	f = 1.0MHz open drain	--	1	--	Ω
Dynamic Characteristics						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = 50V, f = 1.0MHz	--	3871	--	pF
Output Capacitance	C_{oss}		--	217	--	
Reverse Transfer Capacitance	C_{rss}		--	17.1	--	
Total Gate Charge	Q_g	V_{DD} = 640V, I_D = 18A, V_{GS} = 10V	--	62.3	--	nC
Gate-Source Charge	Q_{gs}		--	14.5	--	
Gate-Drain Charge	Q_{gd}		--	23	--	
Turn-on Delay Time	$t_{d(on)}$	V_{DD} = 400V, I_D = 9A, R_G = 25Ω	--	49	--	ns
Turn-on Rise Time	t_r		--	42.6	--	
Turn-off Delay Time	$t_{d(off)}$		--	166	--	
Turn-off Fall Time	t_f		--	13	--	
Drain-Source Body Diode Characteristics						
Body Diode Forward Voltage	V_{SD}	T_J = 25ºC, I_{SD} = 18A, V_{GS} = 0V	--	0.9	1.2	V
Reverse Recovery Time	t_{rr}	V_R = 400V, I_F = I_S, di_F/dt = 100A/μs	--	400	--	ns
Reverse Recovery Charge	Q_{rr}		--	4	--	μC
Peak Reverse Recovery Current	I_{rrm}		--	20	--	A

Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. I_D = 10A, V_{DD} = 50V, R_G = 25Ω, Starting T_J = 25°C
3. Identical low side and high side switch with identical R_G

Typical Characteristics T_J = 25ºC, unless otherwise noted

Figure 1. Output Characteristics

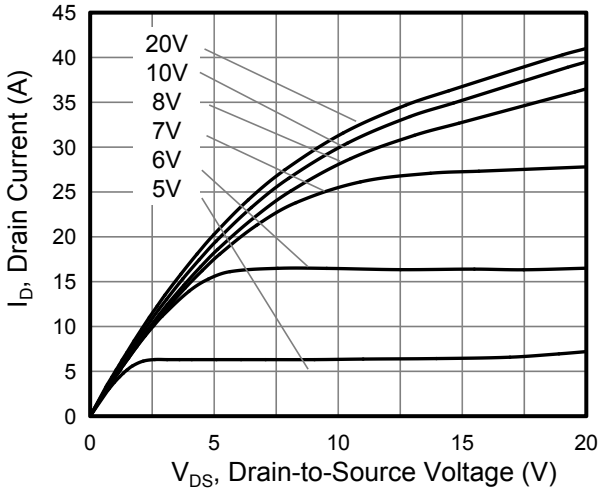


Figure 2. Transfer Characteristics

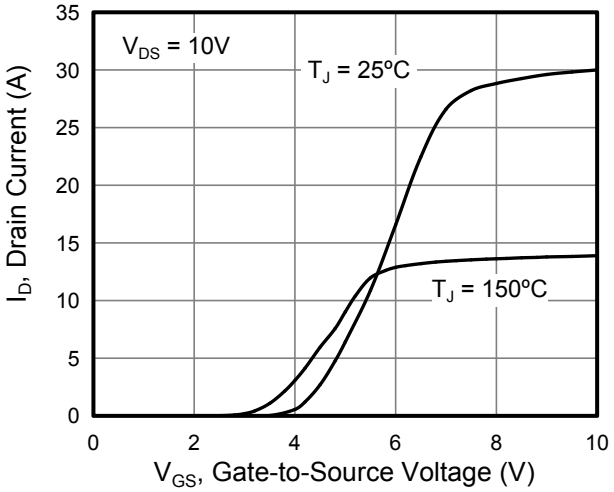


Figure 3. On-Resistance vs. Drain Current

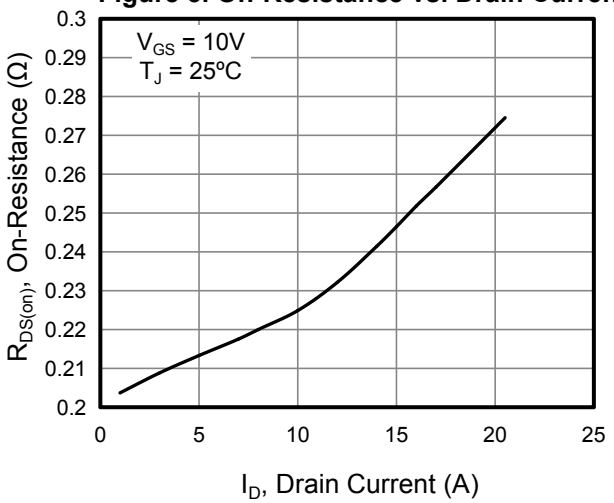


Figure 4. Capacitance

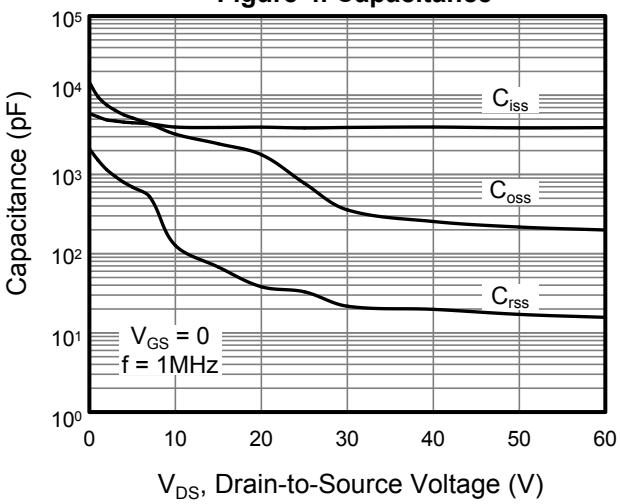


Figure 5. Gate Charge

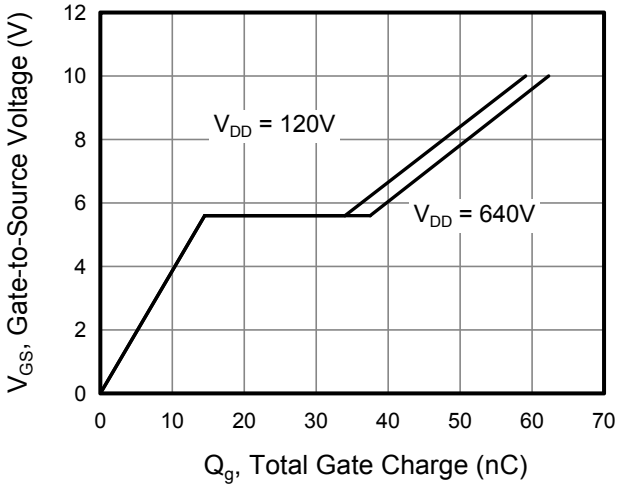
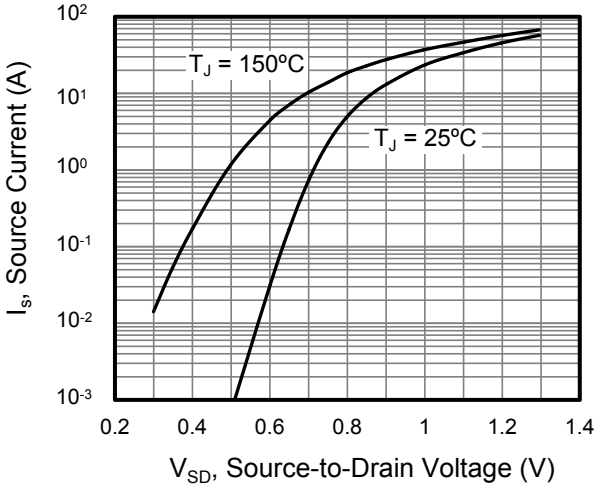


Figure 6. Body Diode Forward Voltage



Typical Characteristics T_J = 25ºC, unless otherwise noted

Figure 7. On-Resistance vs. Junction Temperature

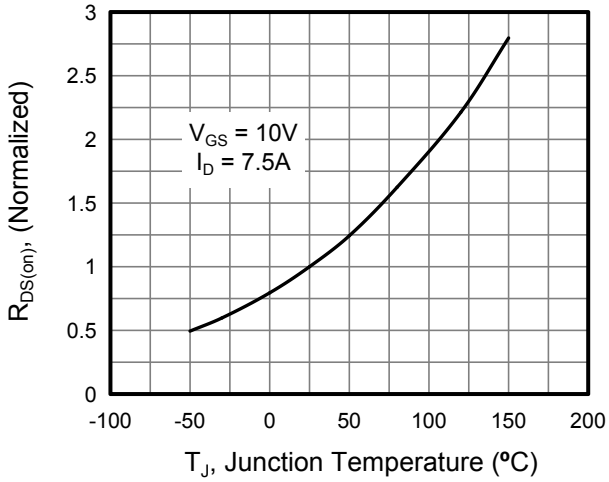


Figure 8. Breakdown voltage vs. Junction Temperature

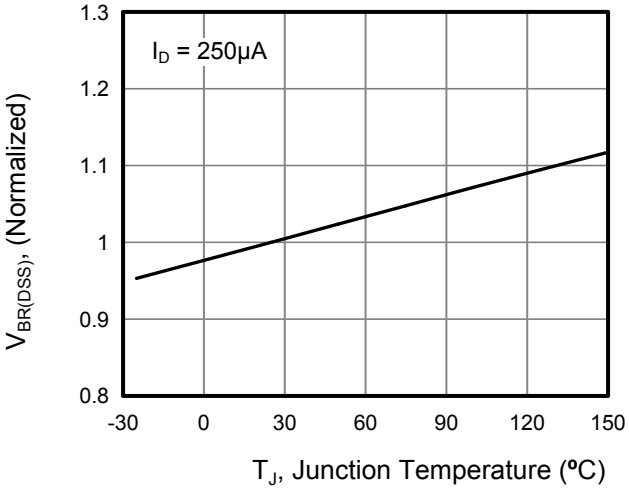


Figure 9. Transient Thermal Impedance For TO-220F/TO-220F-NL

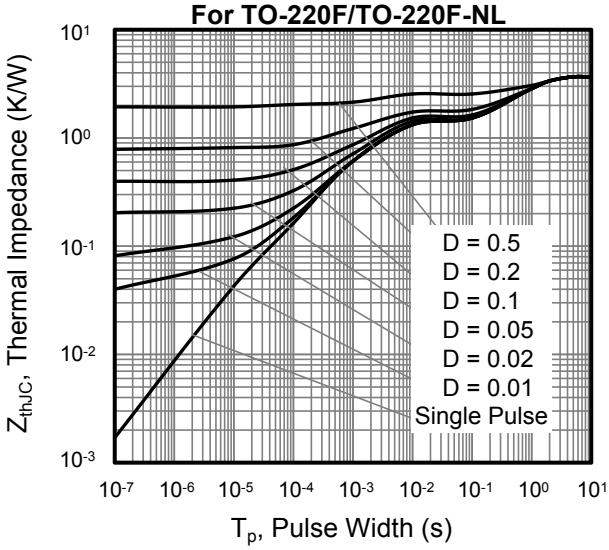


Figure 10. Safe Operation Area For TO-220F/TO-220F-NL

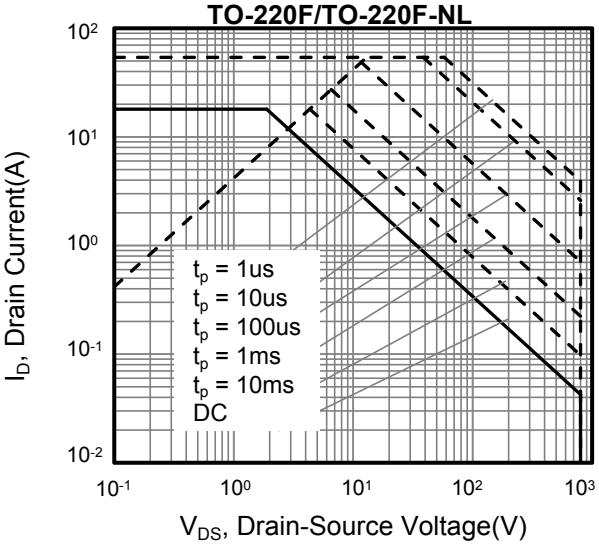


Figure 11. Transient Thermal Impedance For TO-220/TO-247

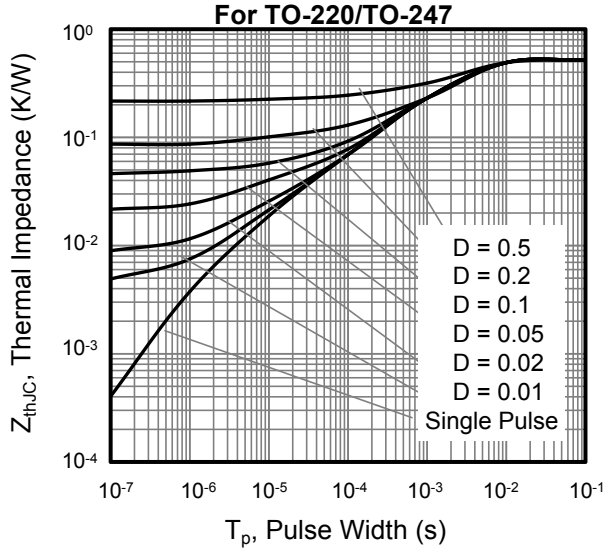
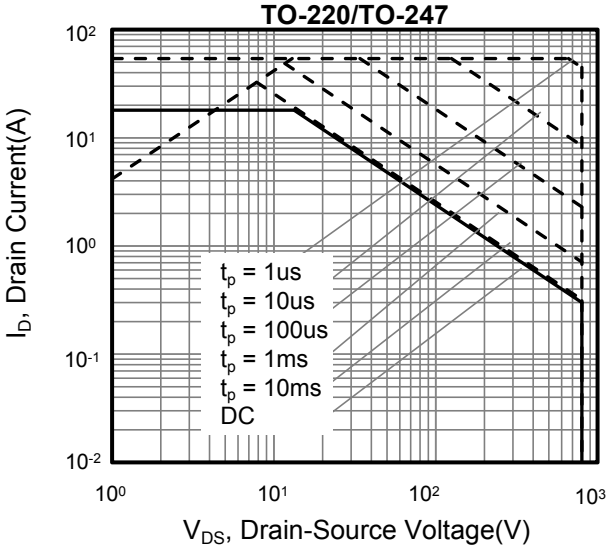


Figure 12. Safe Operation Area For TO-220/TO-247



Typical Characteristics T_J = 25ºC, unless otherwise noted

Figure 13. Typ. Coss Stored Energy

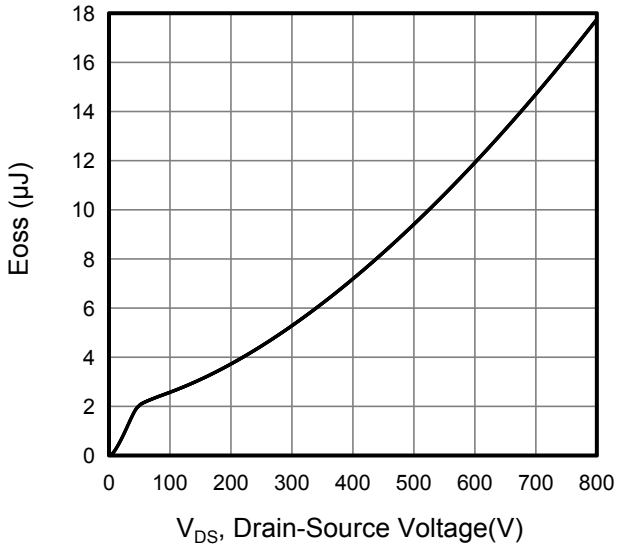


Figure A：Gate Charge Test Circuit and Waveform

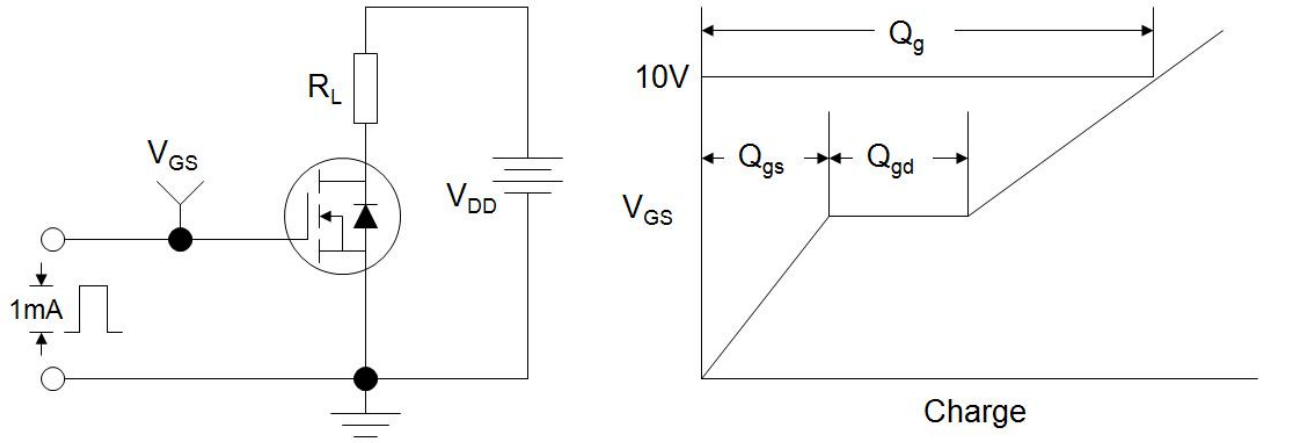


Figure B：Resistive Switching Test Circuit and Waveform

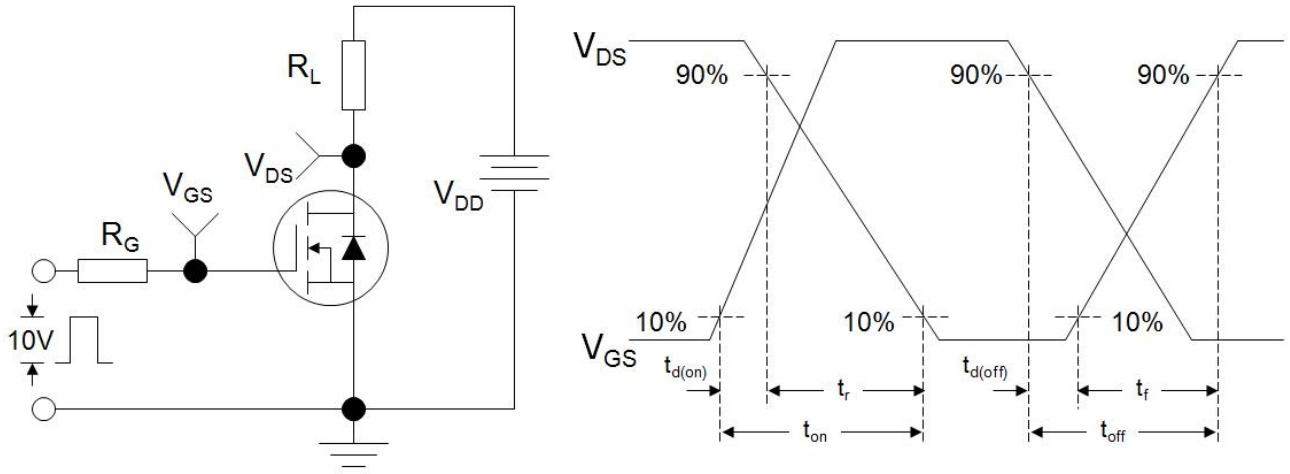
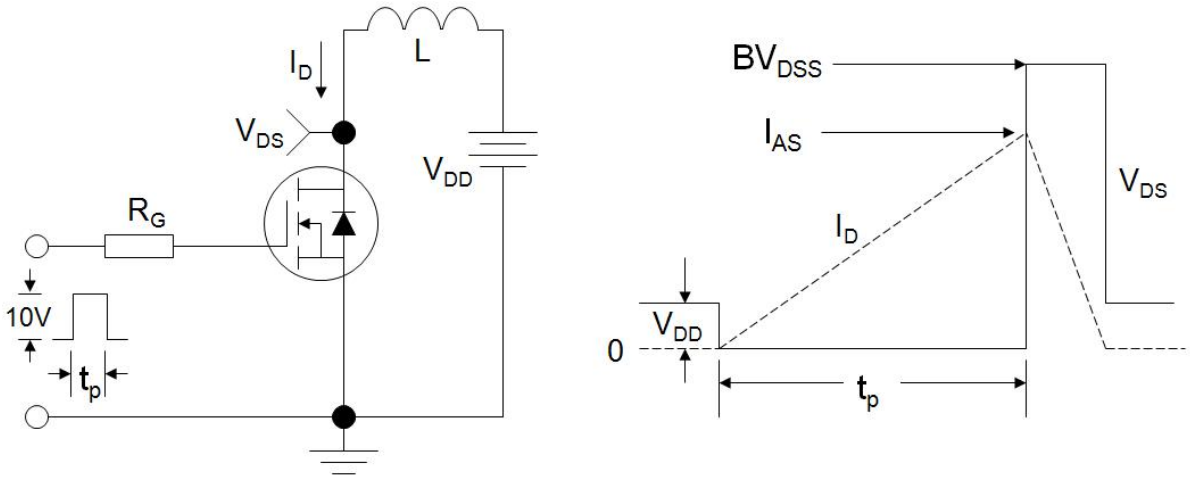
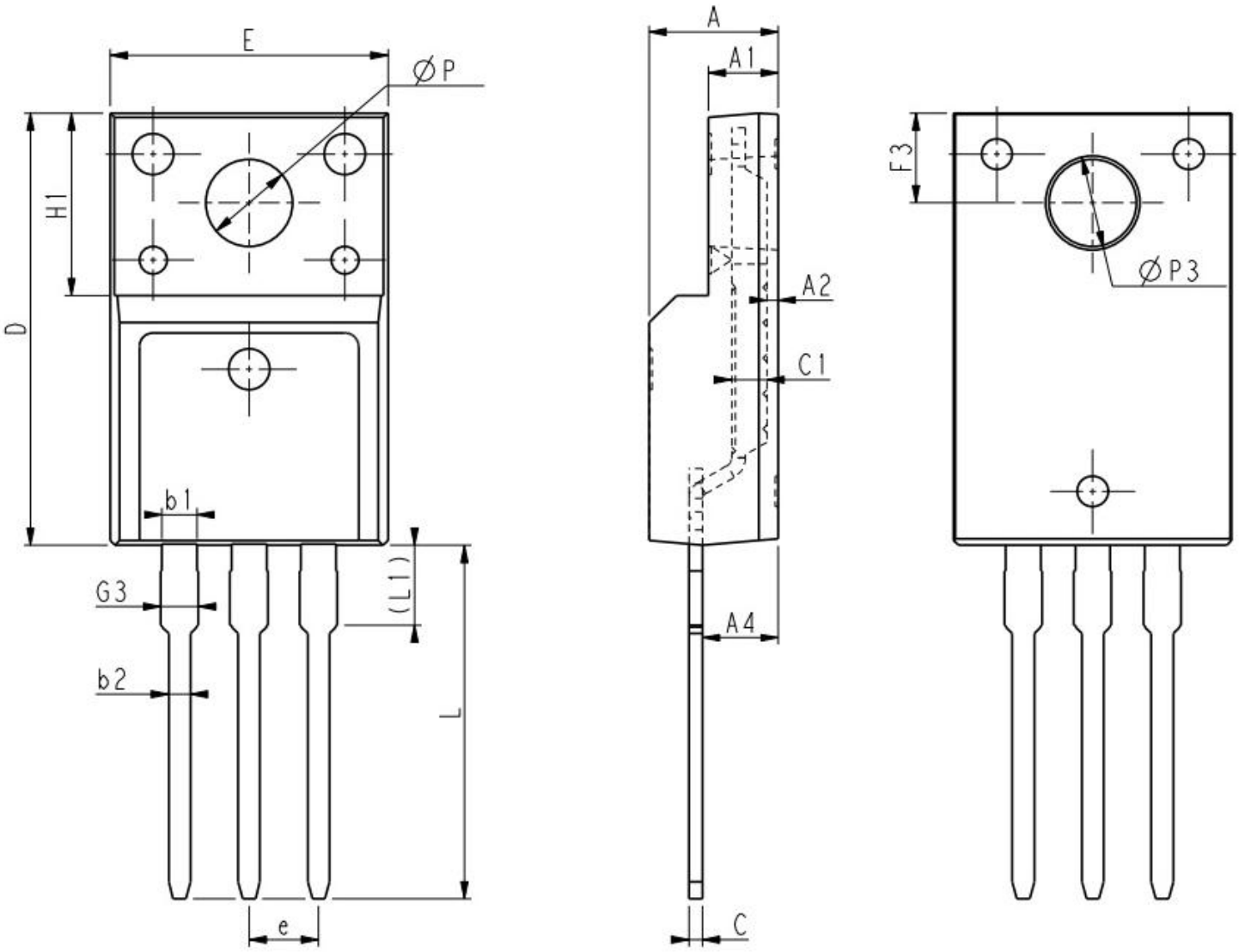


Figure C：Unclamped Inductive Switching Test Circuit and Waveform



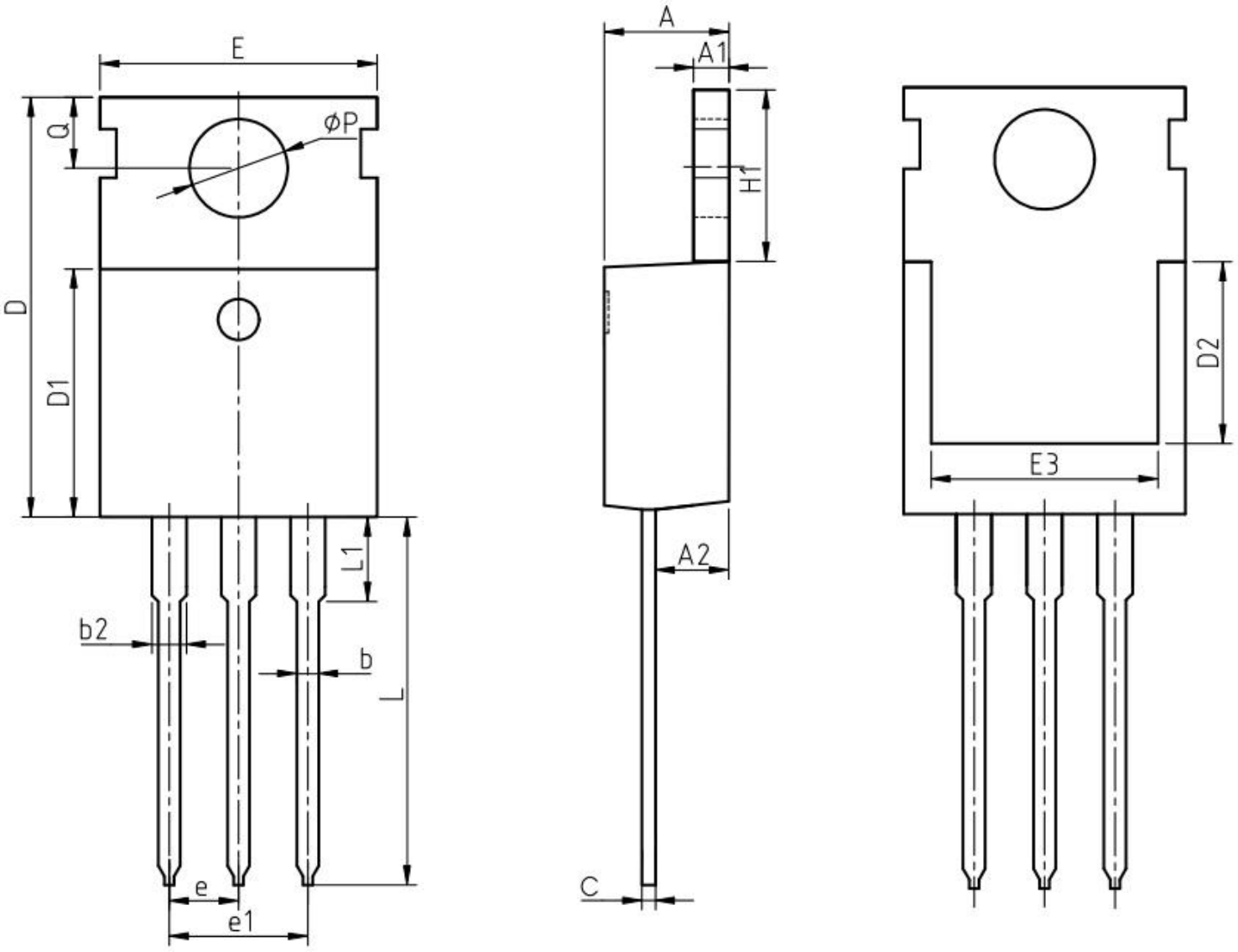
TO-220F（封装厂 H）



Unit:mm			
Symbol	Min.	Nom	Max.
E	9.96	10.16	10.36
A	4.50	4.70	4.90
A1	2.34	2.54	2.74
A2	0.30	0.45	0.60
A4	2.56	2.76	2.96
c	0.40	0.50	0.65
c1	1.20	1.30	1.35
D	15.57	15.87	16.17
H1	6.70REF		

Unit:mm			
Symbol	Min.	Nom	Max.
e	2.54BSC		
L	12.68	12.98	13.28
L1	2.93	3.03	3.13
ΦP	3.03	3.18	3.38
ΦP3	3.15	3.45	3.65
F3	3.15	3.30	3.45
G3	1.25	1.35	1.55
b1	1.18	1.28	1.43
b2	0.70	0.80	0.95

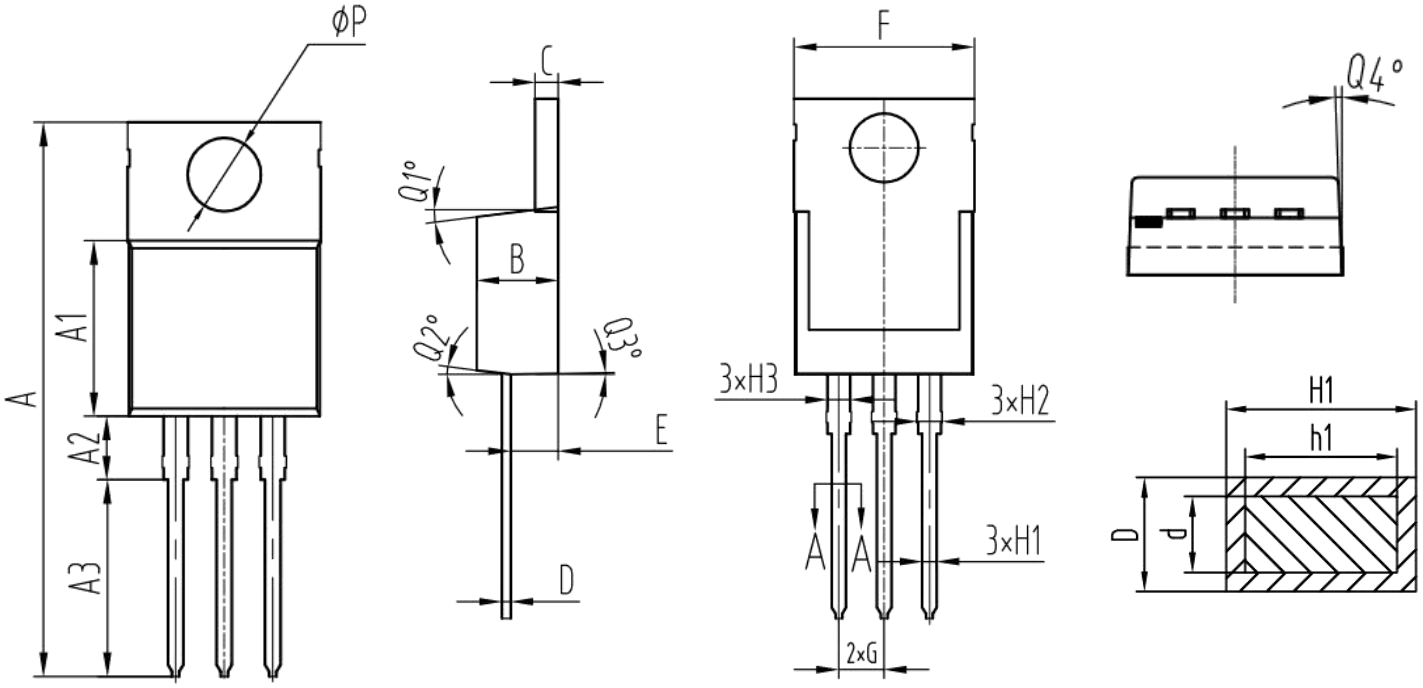
TO-220（封装厂 H）



Unit:mm			
Symbol	Min.	Nom	Max.
A	4.37	4.57	4.77
A1	1.25	1.30	1.40
A2	2.20	2.40	2.60
b	0.70	0.80	0.95
b2	1.17	1.27	1.47
c	0.45	0.50	0.60
D	15.10	15.60	16.10
D1	8.80	9.10	9.40
D2	5.50	-	-

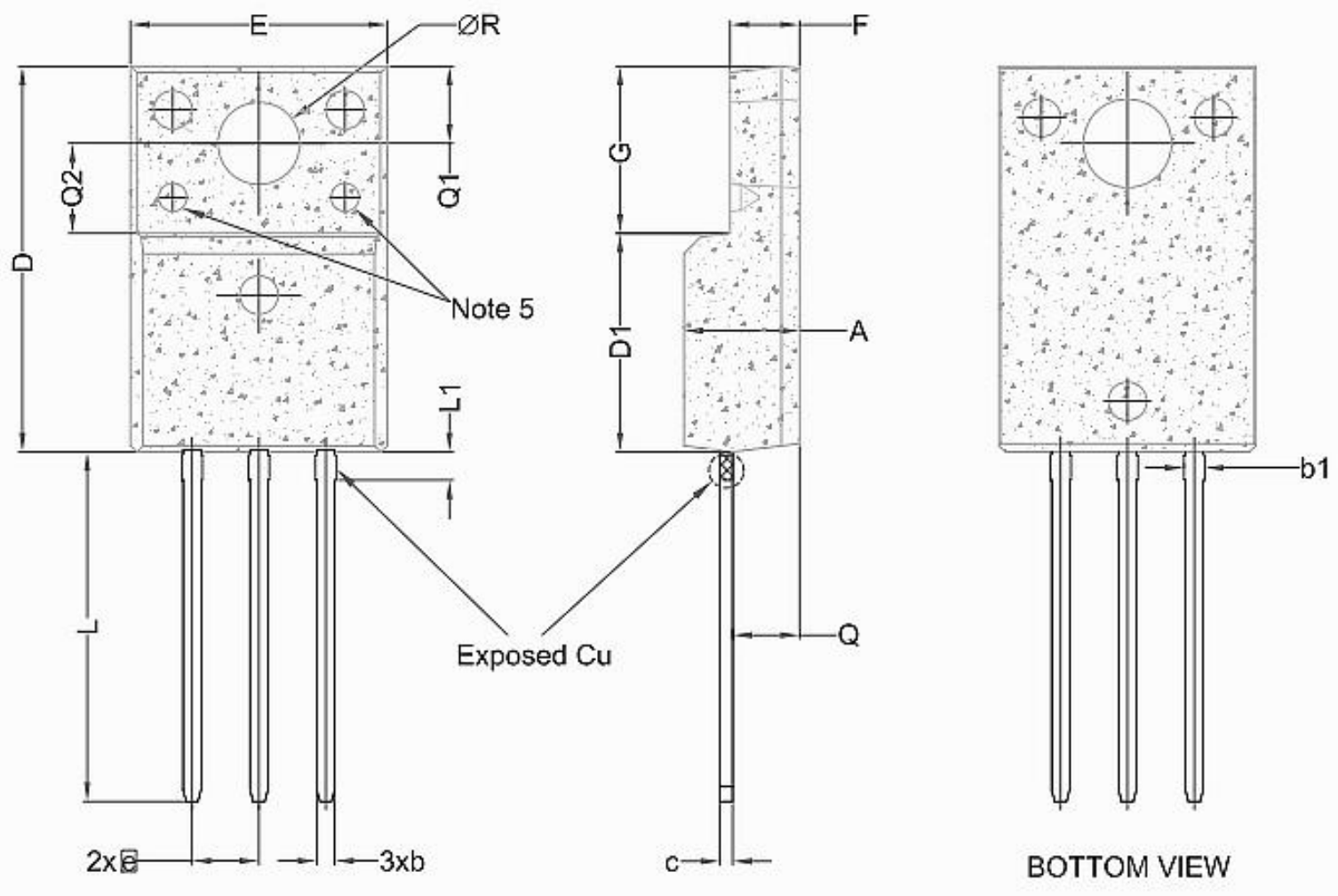
Unit:mm			
Symbol	Min.	Nom	Max.
E	9.70	10.00	10.30
E3	7.00	-	-
e	2.54 BSC		
e1	5.08 BSC		
H1	6.25	6.50	6.85
L	12.75	13.50	13.80
L1	-	3.10	3.40
ΦP	3.40	3.60	3.80
Q	2.60	2.80	3.00

TO-220（封装厂 T）



SYMBOL	MIN	NOM	MAX
A	18.60	18.80	19.00
A1	9.10	9.20	9.30
A2	3.40	3.60	3.80
A3	9.60	9.80	10.00
B	4.45	4.55	4.65
C	1.25	1.30	1.35
D	0.41	—	0.61
d	0.40	0.50	0.60
E	2.52	2.67	2.82
F	9.90	10.10	10.30
G	2.44	2.54	2.64
H1	0.71	—	0.91
h1	0.70	0.80	0.90
H2	1.25	1.35	1.45
H3	1.20	1.27	1.35
øP	3.74	3.84	3.94

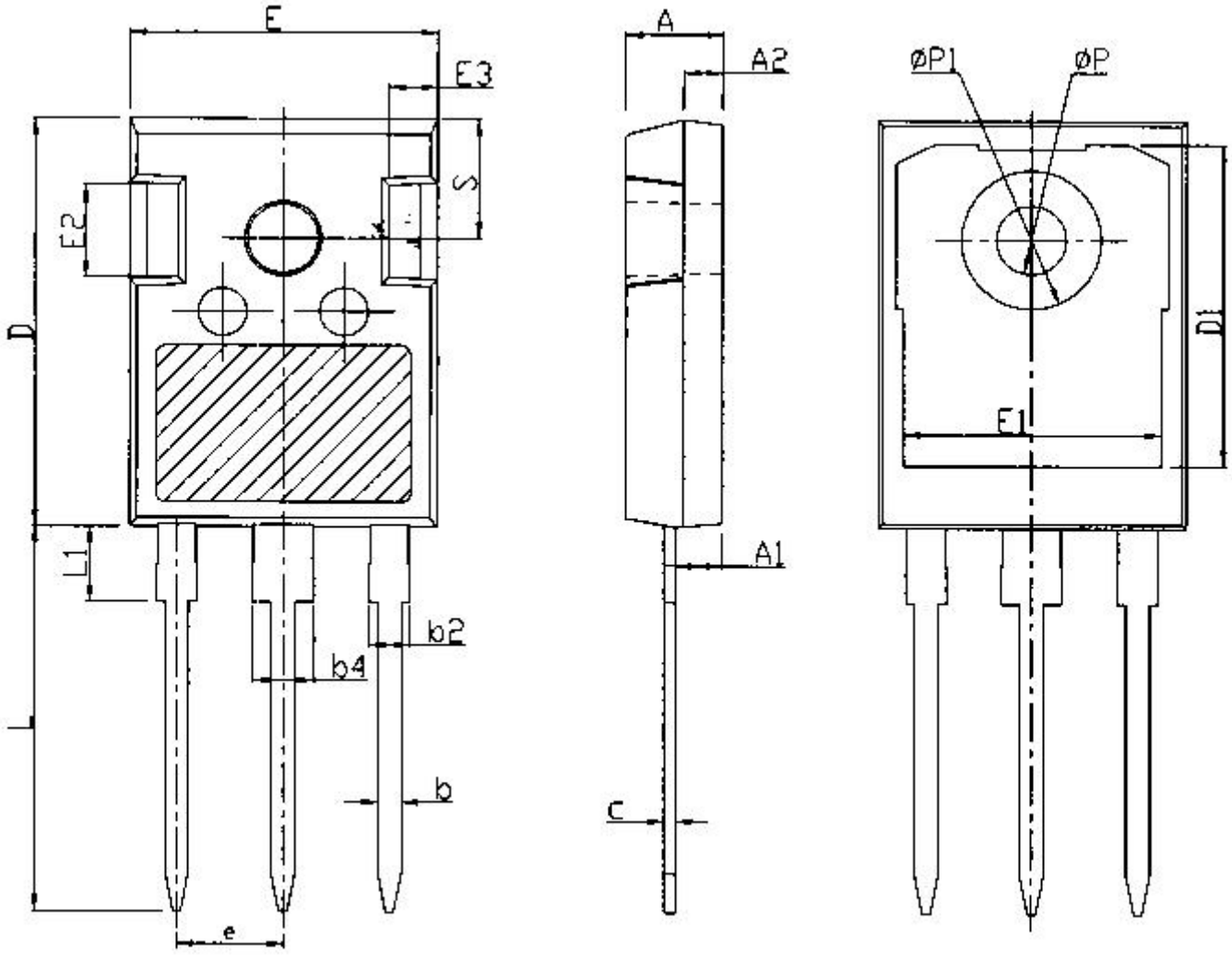
TO-220FP-NL（封装厂 M）



Unit:mm			
Symbol	Min.	Nom	Max.
A	4.30	4.50	4.70
b	0.60	0.70	0.80
b1	0.60	0.80	0.90
c	0.45	0.50	0.60
D	14.70	15.00	15.30
D1	8.50 REF		
e	2.60BSC		
E	9.70	10.00	10.30

Unit:mm			
Symbol	Min.	Nom	Max.
F	2.50	2.70	2.90
G	6.30	6.50	6.70
L	13.40	13.60	13.80
L1	1.00	1.10	1.20
Q	2.50	2.60	2.70
Q1	2.90	3.00	3.10
Q2	3.50 REF		
ΦR	3.00	3.20	3.40

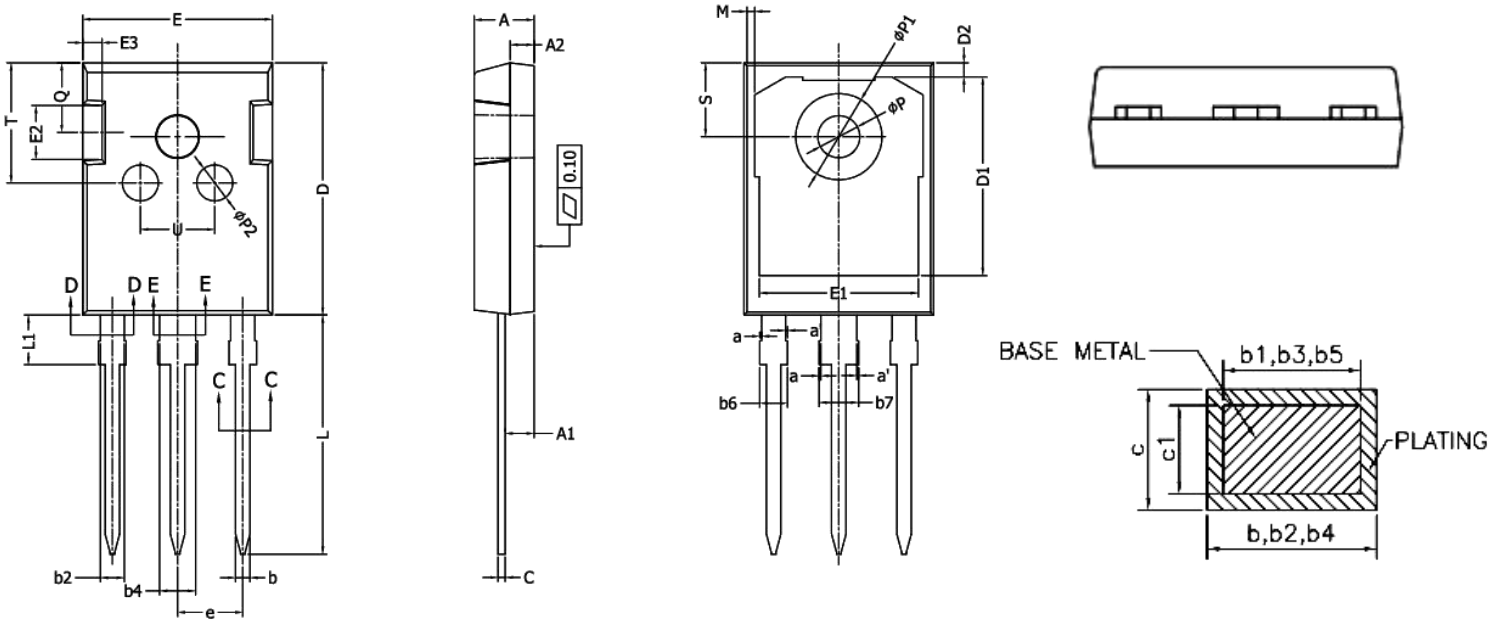
TO-247（封装厂 H）



Unit:mm			
Symbol	Min.	Nom	Max.
A	4.80	5.00	5.20
A1	2.21	2.41	2.61
A2	1.85	2.00	2.15
b	1.11	1.21	1.36
b2	1.91	2.01	2.21
b4	2.91	3.01	3.21
c	0.51	0.61	0.75
D	20.70	21.00	21.30
D1	16.25	16.55	16.85

Unit:mm			
Symbol	Min.	Nom.	Max.
E	15.50	15.80	16.10
E1	13.00	13.30	13.60
E2	4.80	5.00	5.20
E3	2.30	2.50	2.70
e	5.44BSC		
L	19.62	19.92	20.22
L1	-	-	4.30
ΦP	3.40	3.60	3.80
ΦP1	-	-	7.30
S	6.15BSC		

TO-247（封装厂 I）



SYMBOL	MIN	NOM	MAX
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
a	0	---	0.15
a'	0	---	0.15
b	1.16	---	1.26
b1	1.15	1.2	1.22
b2	1.96	---	2.06
b3	1.95	2.00	2.02
b4	2.96	---	3.06
b5	2.96	3.00	3.02
b6	---	---	2.25
b7	---	---	3.25
c	0.59	---	0.66
c1	0.58	0.60	0.62
D	20.90	21.00	21.10
D1	16.25	16.55	16.85
D2	1.05	1.17	1.35
E	15.70	15.80	15.90
E1	13.10	13.30	13.50
E2	4.40	4.50	4.60
E3	2.40	2.50	2.60
e		5.436 BSC	
L	19.80	19.92	20.10
L1	---	---	4.30
M	0.35	---	0.95
P	3.40	3.50	3.60
P1	7.00	---	7.40
P2	2.40	2.50	2.60
Q	5.60	---	6.00
S	6.05	6.15	6.25
T	9.80	---	10.20
U	6.00	---	6.40

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